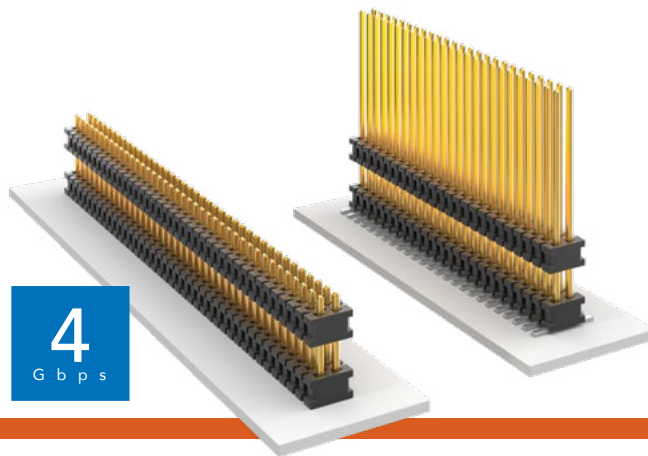


FLEX STACK

MICRO BOARD STACKER

(1.27 mm) .050" PITCH • FW SERIES

4
G b p s



FW Board Mates:

CLP, FLE

Cable Mates:

FFSD

SPECIFICATIONS

Insulator Material:

Black Liquid Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Sn or Au over 50 μ " (1.27 μ m) Ni

Operating Temp Range:

-55 °C to +125 °C

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0.10 mm) .004" max (02-30)

(0.15 mm) .006" max (31-50)*

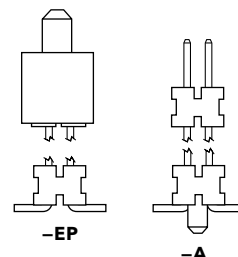
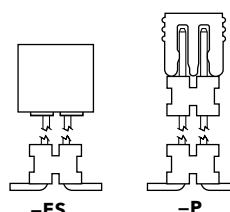
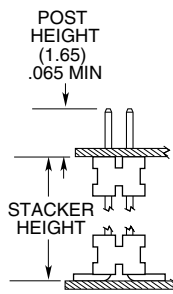
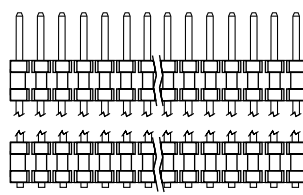
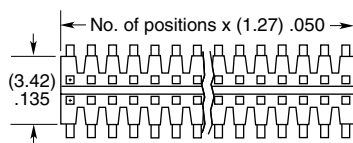
*(.004" stencil solution may be available; contact IPG@samtec.com)

MATED HEIGHT

FW LEAD STYLE	CLP LEAD STYLE	MATED HEIGHT*
FW-XX-03-X-X-233-065	-02	8.13 mm) .329"
FW-XX-03-X-X-303-065		9.91 mm) .390"

*Processing conditions will affect mated height.

SURFACE MOUNT



ALSO AVAILABLE

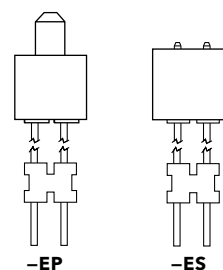
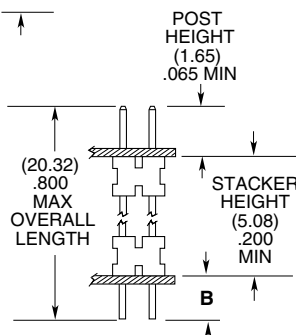
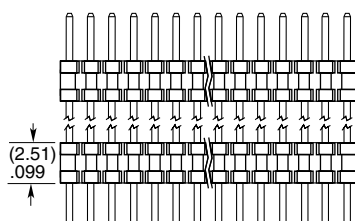
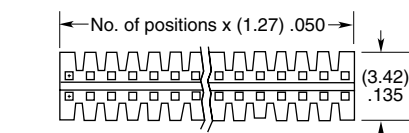
Smaller stack heights
(MOQ Required)

Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

This Series is non-standard, non-returnable.

THROUGH-HOLE



LEAD STYLE	TAIL (B)
-01	(1.14) .045
-02	(1.91) .075
-04	(2.29) .090

-ES
= End Shroud
(-.075 post height only. Mate only with CLP)
(5.46 mm) .215" to (15.49 mm) .610" stacker height only 9 pins/row min.

-EP
= End Shroud with Guide Post
(-.075 post height only. Mate only with CLP)
(5.46 mm) .215" to (15.49 mm) .610" stacker height only 9 pins/row min.

-A
= Alignment Pin
(3 positions min.) (5.46 mm) .215" to (15.75 mm) .620" stacker height only (SMT only)

-P
= Pick & Place Pad
(5 positions min.) (SMT only)

-TR
= Tape & Reel
(Max overall height = Post+Stacker Height+Pad+Alignment Pin = (17.78) .700") (SMT only)

-FR
= Full Reel
Tape & Reel
(must order max. quantity per reel; contact Samtec for quantity breaks) (SMT only)